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B/O FORM PTO 1595 (1/31/92)	U.S. Department of Commerc Patent and Trademark Offic RECORDATION FORM COVER SHEET			
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To the Honorable Commissioner of Patents and Tradem	arks. Please record the attached original documents or copy thereof.			
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☐ Additional names of conveying parties a    Nature of Conveyance	Street Address: 6, Kanda Surugadai 4-chome			
f this document is being filed together with a new application date of the application is:  26 July 2000	4 (b) Patent Numbers:			
5. Name and Address of Party to whom Correspo Concerning this Document Should be Mailed	Additional Numbers Attached.  ndence 6. Total Number of Applications and Patents Involved: 1			
Name: Stanley P. Fisher	7. Total Fee: (37 C.F.R. § 3.41) \$40.00			
Address: Reed Smith Hazel Thomas L 3110 Fairview Park Dr. Suite 1400 Falls Church. Va. 22042	<ul> <li>≅ Enclosed.</li> <li>□ Authorized to be charged to deposit account.</li> </ul>			
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PATENT

**REEL: 011075 FRAME: 0282** 

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku. Tokyo, Japan, receipt of which is hereby acknowledged I do hereby self and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## SEMICONDUCTOR MEMORY DEVICE

invented by me— (if only one is named below) or us— (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire owner-ship of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made.

And I hereby agree to sign and execute any further documents or instruments which may be necessary. lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures:

INVENTORIO

**RECORDED: 09/01/2000** 

INVENIOR(S) (発明者フルネームサイー)			Date Signed (署名日)		
1)	Takashi Akroka	(Takashi AKIOKA)	26 July /20	<u>'00</u>	
2)	Masac Shinozak.	(Masao SHINOZAKI)		)	
3)					
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